N-channel TrenchMOS standard level FET

Rev. 2 — 26 April 2011

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

- AEC Q101 compliant
- Electrostatically robust due to integrated protection diodes

1.3 Applications

 Automotive and general purpose power switching

1.4 Quick reference data

Table 1. Quick reference data Symbol Parameter Conditions Min Typ Max Unit V_{DS} drain-source voltage T_i ≥ 25 °C; T_i ≤ 175 °C 55 V -- I_D drain current $T_{mb} = 25 \ ^{\circ}C$ 57 А --P_{tot} total power dissipation 125 W --Static characteristics drain-source on-state $V_{GS} = 10 \text{ V}; I_{D} = 25 \text{ A};$ 15 18 mΩ R_{DSon} resistance T_i = 25 °C Avalanche ruggedness non-repetitive $I_D = 50 \text{ A}; V_{sup} \le 25 \text{ V};$ 125 mJ E_{DS(AL)S} - $R_{GS} = 50 \Omega; V_{GS} = 10 V;$ drain-source T_{j(init)} = 25 °C; unclamped avalanche energy

Low conduction losses due to low on-state resistance



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Pinning information 2.

| Table 2. | Pinning | information | | |
|----------|---------|--------------------------------------|--------------------|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | G | gate | | _ |
| 2 | D | drain | mb | |
| 3 | S | source | | |
| mb | D | mounting base; connected to drain | | mbb076 S |
| | | | SOT404 (D2PAK) | |

Ordering information 3.

| Table 3. Ordering information | | | | | | |
|---------------------------------------|---------|---|---------|--|--|--|
| Type number | Package | | | | | |
| | Name | Description | Version | | | |
| BUK7618-55 | D2PAK | plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped) | SOT404 | | | |

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2

kV

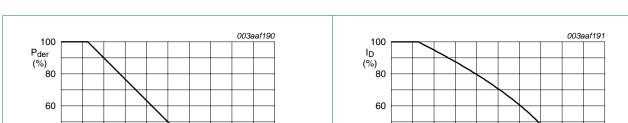
4. Limiting values

Table 4. Limiting values

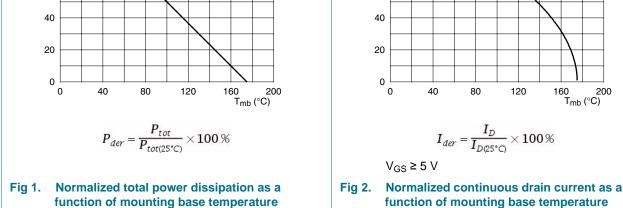
In accordance with the Absolute Maximum Rating System (IEC 60134).

| | | 3 3 1 | | | |
|----------------------|---|---|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | 55 | V |
| V _{DGR} | drain-gate voltage | $R_{GS} = 20 \text{ k}\Omega$ | - | 55 | V |
| V _{GS} | gate-source voltage | | -16 | 16 | V |
| I _D | drain current | T _{mb} = 25 °C | - | 57 | А |
| | | T _{mb} = 100 °C | - | 40 | А |
| I _{DM} | peak drain current | T _{mb} = 25 °C; pulsed | - | 228 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C | - | 125 | W |
| T _{stg} | storage temperature | | -55 | 175 | °C |
| Tj | junction temperature | | -55 | 175 | °C |
| Source-drai | n diode | | | | |
| ls | source current | T _{mb} = 25 °C | - | 57 | А |
| I _{SM} | peak source current | pulsed; T _{mb} = 25 °C | - | 200 | А |
| Avalanche r | uggedness | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | $\label{eq:ID} \begin{array}{l} I_D = 50 \; A; \; V_sup \leq 25 \; V; \; R_GS = 50 \; \Omega; \\ V_GS = 10 \; V; \; T_j(init) = 25 \; ^\circ C; \; unclamped \end{array}$ | - | 125 | mJ |
| Electrostati | c discharge | | | | |
| | | | | | |

V_{esd}



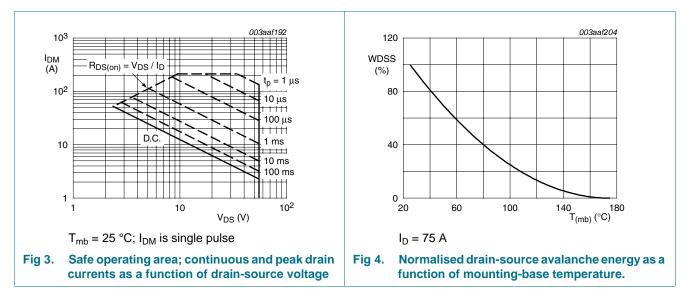
electrostatic discharge voltage HBM; C = 100 pF; R = $1.5 \text{ k}\Omega$; (all pins)



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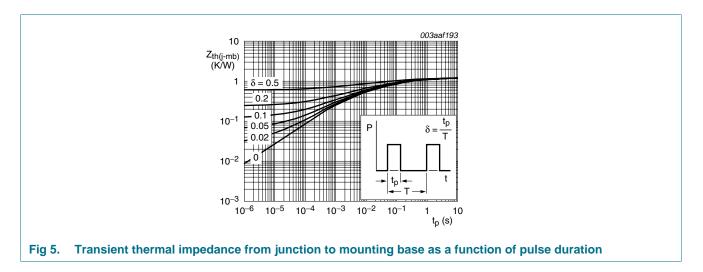
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5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---|------------------------------|-----|-----|-----|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | | - | - | 1.2 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient | minimum footprint; FR4 board | - | 50 | - | K/W |



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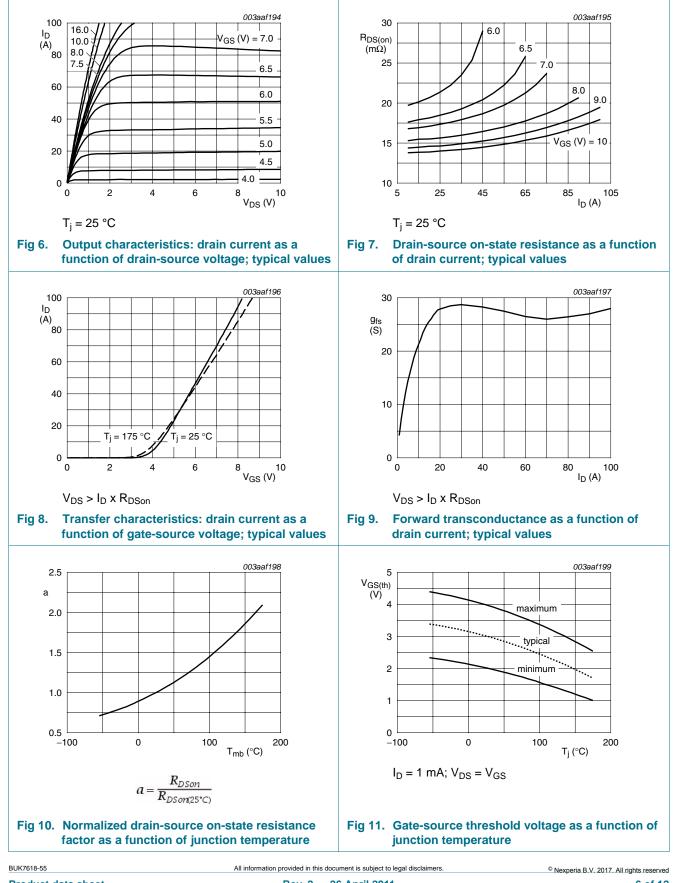
6. Characteristics

| Table 6. | Characteristics | | | | | |
|----------------------|----------------------------------|--|-----|------|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Static cha | racteristics | | | | | |
| V _{(BR)DSS} | drain-source | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | 55 | - | - | V |
| | breakdown voltage | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$ | 50 | - | - | V |
| V _{GS(th)} | gate-source threshold | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$ | 2 | 3 | 4 | V |
| | voltage | I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C | 1 | - | - | V |
| | | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}$ | - | - | 4.4 | V |
| I _{DSS} | drain leakage current | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$ | - | - | 500 | μA |
| | | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 0.05 | 10 | μA |
| I _{GSS} | gate leakage current | V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C | - | 0.02 | 1 | μA |
| | | V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C | - | 0.02 | 1 | μA |
| | | V _{GS} = 10 V; V _{DS} = 0 V; T _j = 175 °C | - | - | 20 | μA |
| | | V _{GS} = -10 V; V _{DS} = 0 V; T _j = 175 °C | - | - | 20 | μA |
| R _{DSon} | drain-source on-state resistance | V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C | - | - | 38 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C | - | 15 | 18 | mΩ |
| V _{(BR)GSS} | gate-source | V _{DS} = 0 V; T _j = 25 °C; I _G = 1 mA | 16 | - | - | V |
| | breakdown voltage | V _{DS} = 0 V; T _j = 25 °C; I _G = -1 mA | 16 | - | - | V |
| Dynamic | characteristics | | | | | |
| C _{iss} | input capacitance | $V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$ | - | 1500 | 2000 | pF |
| C _{oss} | output capacitance | T _j = 25 °C | - | 370 | 470 | pF |
| C _{rss} | reverse transfer capacitance | | - | 170 | 250 | pF |
| t _{d(on)} | turn-on delay time | V_{DS} = 30 V; R_{L} = 1.2 Ω ; V_{GS} = 10 V; | - | 15 | 22 | ns |
| t _r | rise time | $R_{G(ext)} = 10 \ \Omega; I_D = 25 \ A; T_j = 25 \ ^{\circ}C$ | - | 30 | 60 | ns |
| t _{d(off)} | turn-off delay time | | - | 35 | 50 | ns |
| t _f | fall time | | - | 25 | 38 | ns |
| L _D | internal drain inductance | measured from upper edge of drain mounting base to centre of die; $T_j = 25 \ ^{\circ}C$ | - | 2.5 | - | nH |
| L _S | internal source inductance | measured from source lead soldering point to source bond pad; $T_j = 25 \text{ °C}$ | - | 7.5 | - | nH |
| 9 _{fs} | transfer conductance | V _{DS} = 25 V; I _D = 25 A; T _j = 25 °C | 6 | 30 | - | S |
| Source-di | rain diode | | | | | |
| V _{SD} | source-drain voltage | $I_{S} = 50 \text{ A}; V_{GS} = 0 \text{ V}; T_{j} = 25 \text{ °C}$ | - | 1 | - | V |
| | | $I_{S} = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_{j} = 25 \text{ °C}$ | - | 0.95 | 1.2 | V |
| t _{rr} | reverse recovery time | $I_{S} = 50 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s};$ | - | 48 | - | ns |
| Q _r | recovered charge | V_{GS} = -10 V; V_{DS} = 30 V; T_j = 25 °C | - | 0.1 | - | μC |

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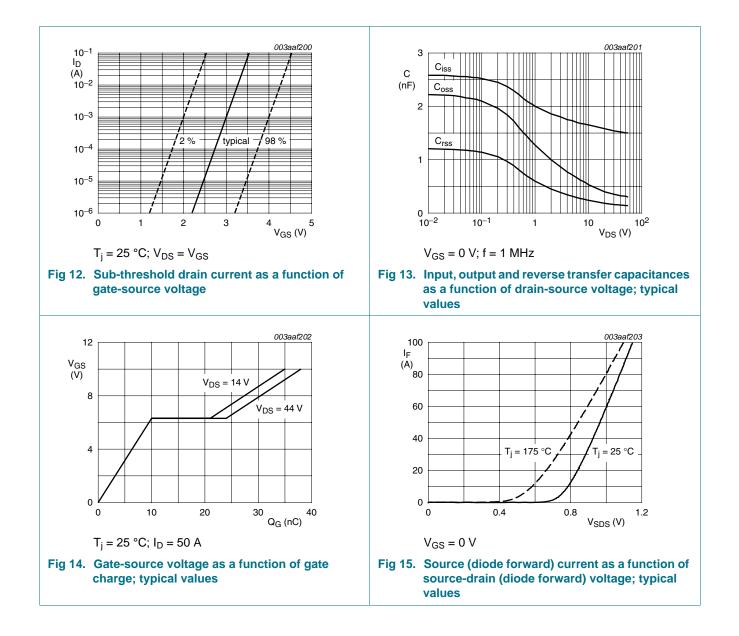
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7. Package outline

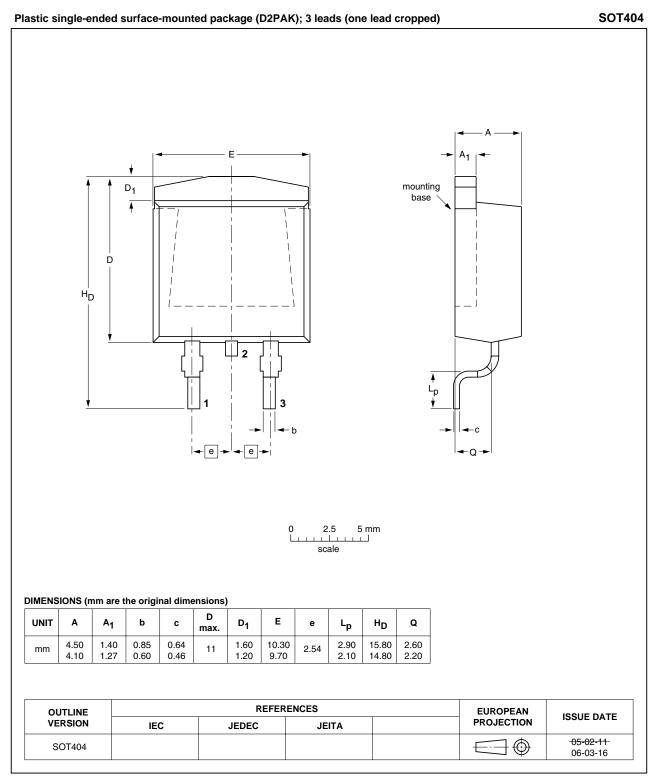


Fig 16. Package outline SOT404 (D2PAK)

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8. Revision history

| BUK7618-55 v.2 | 20110426 | | - | = |
|----------------|---|------------------------------|-------------------------|-----------------------------|
| | 20110.20 | Product data sheet | - | BUK7618-55_1 |
| Modifications: | The format of of NXP. | this data sheet has been rec | designed to comply with | the new identity guidelines |
| | Legal texts ha | ve been adapted to the new | company name where | appropriate. |
| BUK7618-55_1 | 19980401 | Product specification | - | - |

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Product data sheet

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9. Legal information

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| Document status [1] [2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

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